

OUR BUSINESS

MPPC[®] (Multi-Pixel Photon Counter)

NEW

S13360 series

MPPCs for precision measurement

MPPC is a type of device called SiPM (silicon photomultipliers). It is a new type of photon counting device that consists of multiple Geiger mode APD (avalanche photodiode) pixels. It is an opto-semiconductor with outstanding photon counting capability and low operating voltage and is immune to the effects of magnetic fields.

The S13360 series are MPPCs for precision measurement. The MPPCs inherits the superb low afterpulse characteristics of previous products and further provide lower crosstalk and lower dark count. They are suitable for precision measurement, such as flow cytometry, DNA sequencer, laser microscope, and fluorescence measurement, that requires low noise characteristics.

Features

- Reduced crosstalk and dark count (compared to previous products)
- \rightarrow Outstanding photon counting capability (outstanding photon detection efficiency versus numbers of incident photons)
- Compact
- Operates at room temperature
- Low voltage (VBR=53 V typ.) operation
- High gain: 10⁵ to 10⁶
- Excellent time resolution
- Immune to the effects of magnetic fields
- Operates with simple readout circuit
- MPPC module also available (sold separately)

Applications

- Fluorescence measurement
- Laser microscopes
- Flow cytometry
- DNA sequencers
- Environmental analysis
- Various academic research

Lower noise

When an MPPC detects photons, the output may contain spurious pulses, namely afterpulse and crosstalk, that are separate from the output pulses of the incident photons. Afterpulses are output later than the timing at which the incident light is received. Crosstalk is output from other pixels at the same time as the detection of light.

Previous products achieved lower afterpulse through the improvement of material and wafer process technology, but with the S13360 series, low crosstalk has been achieved in addition to low afterpulse.

Pulse waveform comparison (typical example)



Selection guide

Type no.	Pixel pitch (µm)	Effective photosensitive area (mm)	Number of pixels	Package	Fill factor (%)			
S13360-1325CS		12, 12	2669	Ceramic				
S13360-1325PE		1.5 × 1.5	2000	Surface mount type				
S13360-3025CS	25	20,420	14400	Ceramic	47			
S13360-3025PE	25	5.0 × 5.0	14400	Surface mount type	47			
S13360-6025CS		60,460	E7600	Ceramic				
S13360-6025PE		0.0 × 0.0	57600	Surface mount type				
S13360-1350CS	50	12, 12	667	Ceramic				
S13360-1350PE		1.5 × 1.5	007	Surface mount type				
S13360-3050CS		2020	2600	Ceramic	74			
S13360-3050PE	50	5.0 × 5.0	3000	Surface mount type	/4			
S13360-6050CS		60,460	14400	Ceramic				
S13360-6050PE		0.0 × 0.0	14400	Surface mount type				
S13360-1375CS		12, 12	205	Ceramic				
S13360-1375PE		1.5 X 1.5	205	Surface mount type				
S13360-3075CS	76	20,420	1600	Ceramic	00			
S13360-3075PE	/5	5.0 × 5.0	1000	Surface mount type	02			
S13360-6075CS		60,460	6400	Ceramic				
S13360-6075PE		0.0 X 0.0	0400	Surface mount type				

Structure / Absolute maximum ratings

Type no. (package)	Window material	Refractive index of window material	Absolute maximum ratings					
			Operating temperature ^{*1} Topr (°C)	Storage temperature ^{*1} Tstg (°C)	Soldering conditions	Reflow soldering conditions ^{*2} Tsol		
S13360-****CS (ceramic)	Silicone resin	1.41	20 to 160	20 to 1 80	350 °C or less, once, within 3 seconds ^{*3}	-		
S13360-****PE (surface mount type)	Epoxy resin	1.55	-20 10 +00	-20 10 +60	-	Peak temperature: 240 °C, twice (see P.11)		

*1: No condensation

*2: JEDEC level 5a

*3: Separate by at least 1 mm from the lead root.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.



Electrical and optical characteristics (Typ. Ta=25 °C, unless otherwise noted)

					Dark o	ount*5						Tem-
Type no.	Measure- ment conditions	Spectral response range λ	Peak sensitivity wavelength λp	Photon detection efficiency PDE ^{*4} $\lambda = \lambda p$	Тур.	Max.	Terminal capaci- tance Ct	Gain M	Break- down voltage VBR	Crosstalk probability	Recom- mended operating voltage Vop	perature coefficient at recom- mended operating voltage ∆TVOp
		(nm)	(nm)	(%)	(kcps)	(kcps)	(pF)		(V)	(%)	(V)	(mV/°C)
S13360-1325CS		270 to 900			70	210	60	7.0 × 10 ⁵		1	Vbr + 5	
S13360-1325PE		320 to 900				210						
S13360-3025CS	Vover	270 to 900		25	400	1200	00 320					
S13360-3025PE	=5 V	320 to 900		25		1200						
S13360-6025CS		270 to 900			1600	5000	1200					
S13360-6025PE		320 to 900				5000	1200					
S13360-1350CS		270 to 900		40	90	270	60	1.7 × 106	53 ± 5 3	3	Vbr + 3	54
S13360-1350PE		320 to 900				270	00					
S13360-3050CS	Vover	270 to 900	450		500	1500	320 1.7 × 10					
S13360-3050PE	=3 V	320 to 900	450			1300		1.7 X 10				
S13360-6050CS		270 to 900			2000	6000						
S13360-6050PE		320 to 900				0000	1200					
S13360-1375CS	Vover =3 V	270 to 900			90	270	<u> </u>	$ \begin{array}{c} 60 \\ 320 \\ 4.0 \times 10^{6} \end{array} $			1	
S13360-1375PE		320 to 900		50		270	60			7	Vbr + 3	
S13360-3075CS		270 to 900	1		500	1500	320					
S13360-3075PE		320 to 900										
S13360-6075CS		270 to 900			2000	6000	1200					
S13360-6075PE		320 to 900			2000	0000	1280					

*4: Photon detection efficiency does not include crosstalk or afterpulses.

*5: Threshold=0.5 p.e.

Note: The above characteristics were measured at the operating voltage that yields the listed gain. (See the data attached to each product.)

Connection example





KAPDC0024EB

MPPC (Multi-Pixel Photon Counter)



Photon detection efficiency vs. wavelength (typical example)

Photon detection efficiency does not include crosstalk or afterpulses.

Wavelength (nm)

KAPDB0325EA





Overvoltage specifications of gain, crosstalk probability, photon detection efficiency (typical example) Pixel pitch: 25 µm

KAPDB0324EA



Overvoltage (V)



MPPC characteristics vary with the operating voltage. Although increasing the operating voltage improves the photon detection efficiency and time resolution, it also increases the dark count and crosstalk at the same time, so an optimum operating voltage must be selected to match the application.



Dimensional outlines (unit: mm)





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Recommended land pattern (Unit: mm)



KAPDC0057EA

Temperature profile measurement example using our experimental hot-air reflow oven (S13360-1350PE)



• This surface mount type package product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 25 °C or less and a humidity of 60% or less, and perform soldering within 24 hours.

• The effect that the product is subject to during reflow soldering varies depending on the circuit board and reflow furnace that are used. Before actual reflow soldering, check for any problems by testing out the reflow soldering methods in advance.



Precautions

· If necessary, incorporate appropriate protective circuits in power supplies, devices, and measuring instruments to prevent overvoltage and overcurrent.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- · Metal, ceramic, plastic package products
- · Surface mount type products

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Information described in this material is current as of October, 2015.

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